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Team Nexperia

PEMD14; PUMD14

NPN/PNP resistor-equipped transistors; R1 = 47 k Ω , R2 = open

Rev. 02 — 2 September 2009

Product data sheet

1. Product profile

1.1 General description

NPN/PNP resistor-equipped transistors

| Table 1. | Product | overview |
|----------|---------------|-----------|
| | 1 I O G G G C | 010111011 |

| Type number | Package | Package | | NPN/NPN complement |
|-------------|---------|---------|--------|-----------------------|
| | NXP | JEITA | | |
| PEMD14 | SOT666 | - | PEMB14 | PEMH14 |
| PUMD14 | SOT363 | SC-88 | PUMB14 | PUMH14 |

1.2 Features

- Built-in bias resistors
- Simplifies circuit design
- Reduces component count
- Reduces pick and place cost

1.3 Applications

- Low current peripheral driver
- Control of IC inputs
- Replacement of general-purpose transistors in digital applications

1.4 Quick reference data

| Quick reference data | | | | | |
|---------------------------|---------------------------------------------------------------|--------------------------------------------------------------------------|-------------------------------------------------------------------------------|--------------------------------------------------------------------------------|----------------------------------------------------------------------------------------|
| Parameter | Conditions | Min | Тур | Max | Unit |
| collector-emitter voltage | open base | - | - | 50 | V |
| output current (DC) | | - | - | 100 | mA |
| bias resistor 1 (input) | | 33 | 47 | 61 | kΩ |
| | Parameter collector-emitter voltage output current (DC) | ParameterConditionscollector-emitter voltageopen baseoutput current (DC) | ParameterConditionsMincollector-emitter voltageopen base-output current (DC)- | ParameterConditionsMinTypcollector-emitter voltageopen baseoutput current (DC) | ParameterConditionsMinTypMaxcollector-emitter voltageopen base50output current (DC)100 |



PEMD14; PUMD14

006aaa269

NPN/PNP resistor-equipped transistors; R1 = 47 kΩ, R2 = open

2. Pinning information

| Table 3. | Pinning | | | | | |
|----------|------------------------|--------------------|--------|--|--|--|
| Pin | Description | Simplified outline | Symbol | | | |
| 1 | GND (emitter) TR1 | | | | | |
| 2 | input (base) TR1 | 6 5 4 | | | | |
| 3 | output (collector) TR2 | | | | | |
| 4 | GND (emitter) TR2 | | | | | |
| 5 | input (base) TR2 | | | | | |
| 6 | output (collector) TR1 | 001aab555 | R1 | | | |
| | | | | | | |

3. Ordering information

| Table 4. | Ordering | information |
|----------|----------|-------------|
|----------|----------|-------------|

| Type number | Package | | |
|-------------|---------|------------------------------------------|---------|
| Name | | Description | Version |
| PEMD14 | - | plastic surface mounted package; 6 leads | SOT666 |
| PUMD14 | SC-88 | plastic surface mounted package; 6 leads | SOT363 |

4. Marking

| Table 5. Marking codes | |
|------------------------|-----------------------------|
| Type number | Marking code ^[1] |
| PEMD14 | 5B |
| PUMD14 | T2* |

[1] * = -: made in Hong Kong

* = p: made in Hong Kong

* = t: made in Malaysia

* = W: made in China

PEMD14; PUMD14

NPN/PNP resistor-equipped transistors; R1 = 47 k Ω , R2 = open

5. Limiting values

| Symbol | Parameter | Conditions | Min | Max | Unit |
|------------------|--------------------------------|------------------------------|------------------|------|------|
| Per transis | stor; for the PNP transistor v | with negative polar | ity | | |
| V _{CBO} | collector-base voltage | open emitter | - | 50 | V |
| V _{CEO} | collector-emitter voltage | open base | - | 50 | V |
| V _{EBO} | emitter-base voltage | open collector | - | 5 | V |
| lo | output current (DC) | | - | 100 | mA |
| I _{CM} | peak collector current | | - | 100 | mA |
| P _{tot} | total power dissipation | $T_{amb} \le 25 \ ^{\circ}C$ | | | |
| | SOT363 | | <u>[1]</u> _ | 200 | mW |
| | SOT666 | | <u>[1] [2]</u> _ | 200 | mW |
| T _{stg} | storage temperature | | -65 | +150 | °C |
| Tj | junction temperature | | - | 150 | °C |
| T _{amb} | ambient temperature | | -65 | +150 | °C |
| Per device |) | | | | |
| P _{tot} | total power dissipation | $T_{amb} \le 25 \ ^{\circ}C$ | | | |
| | SOT363 | | <u>[1]</u> _ | 300 | mW |
| | SOT666 | | [1] [2] _ | 300 | mW |

[1] Device mounted on a FR4 printed-circuit board, single-sided copper, tin-plated and standard footprint.

[2] Reflow soldering is the only recommended soldering method.

6. Thermal characteristics

| Table 7. | Thermal characteristics | | | | | |
|----------------------|------------------------------------------------|------------------------------|-------------------------|-----|-----|------|
| Symbol | Parameter | Conditions | Min | Тур | Мах | Unit |
| Per trans | istor | | | | | |
| R _{th(j-a)} | thermal resistance from junction to ambient | $T_{amb} \le 25 \ ^{\circ}C$ | | | | |
| | SOT363 | | <u>[1]</u> - | - | 625 | K/W |
| | SOT666 | | <u>[1] [2]</u> _ | - | 625 | K/W |
| Per devic | e | | | | | |
| R _{th(j-a)} | thermal resistance from junction to ambient | $T_{amb} \le 25 \ ^{\circ}C$ | | | | |
| | SOT363 | | <u>[1]</u> - | - | 416 | K/W |
| | SOT666 | | <u>[1]</u> <u>[2]</u> _ | - | 416 | K/W |

[1] Device mounted on a FR4 printed-circuit board, single-sided copper, tin-plated and standard footprint.

[2] Reflow soldering is the only recommended soldering method.

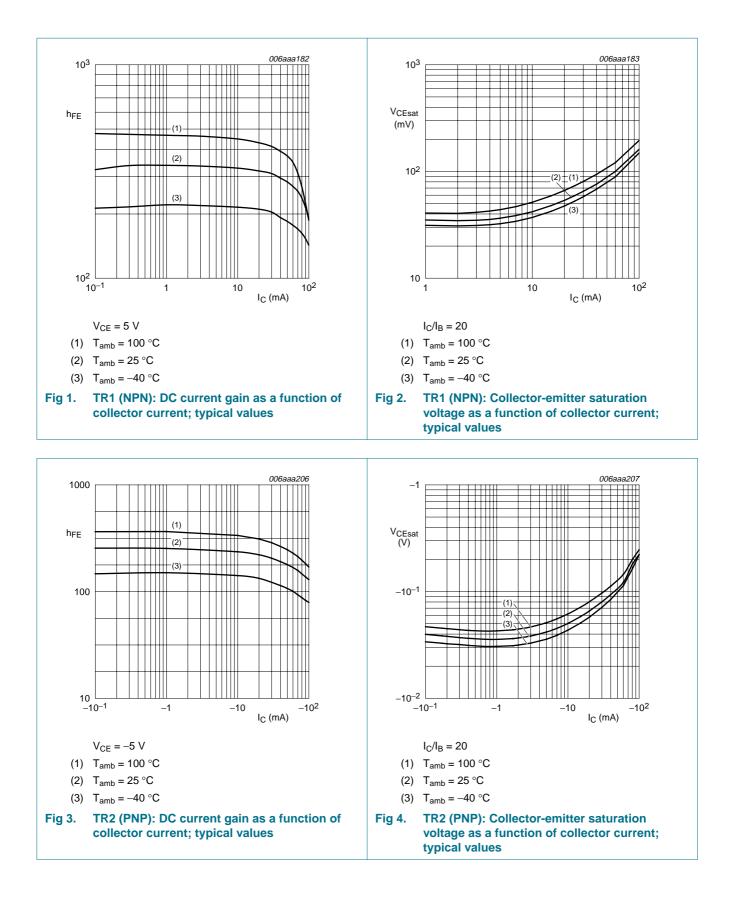
NPN/PNP resistor-equipped transistors; R1 = 47 kΩ, R2 = open

7. Characteristics

| Symbol | Parameter | Conditions | Min | Тур | Max | Unit |
|-------------------------------------------------------|-----------------------------------------|------------------------------------------------------------------------------------|-----|-----|-----|------|
| Per transis | stor; for the PNP transis | tor with negative polarity | | | | |
| I _{CBO} | collector-base cut-off current | $V_{CB} = 50 \text{ V}; I_E = 0 \text{ A}$ | - | - | 100 | nA |
| I _{CEO} collector-emitter cut-off current | collector-emitter | $V_{CE} = 30 \text{ V}; \text{ I}_{B} = 0 \text{ A}$ | - | - | 1 | μA |
| | cut-off current | $V_{CE} = 30 \text{ V}; I_B = 0 \text{ A};$ T _j = 150 °C | - | - | 50 | μA |
| I _{EBO} | emitter-base cut-off current | $V_{EB} = 5 \text{ V}; I_{C} = 0 \text{ A}$ | - | - | 100 | nA |
| h _{FE} | DC current gain | $V_{CE} = 5 \text{ V}; I_{C} = 1 \text{ mA}$ | 100 | - | - | |
| V _{CEsat} | collector-emitter saturation voltage | I_{C} = 10 mA; I_{B} = 0.5 mA | - | - | 150 | mV |
| R1 | bias resistor 1 (input) | | 33 | 47 | 61 | kΩ |
| C _c | collector capacitance | $V_{CB} = -10 \text{ V}; \text{ I}_{E} = \text{i}_{e} = 0 \text{ A};$ f = 1 MHz | | | | |
| | TR1 (NPN) | | - | - | 2.5 | pF |
| | TR2 (PNP) | | - | - | 3 | pF |

PEMD14; PUMD14

NPN/PNP resistor-equipped transistors; R1 = 47 k Ω , R2 = open



PEMD14; PUMD14

NPN/PNP resistor-equipped transistors; R1 = 47 k Ω , R2 = open

8. Package outline

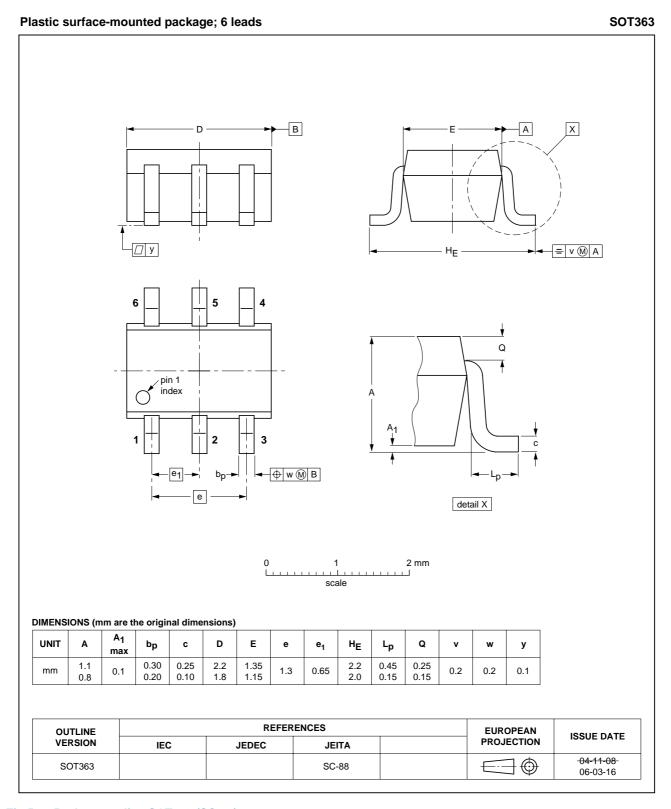


Fig 5. Package outline SOT363 (SC-88)

PEMD14_PUMD14_2
Product data sheet

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PEMD14; PUMD14

NPN/PNP resistor-equipped transistors; R1 = 47 k Ω , R2 = open

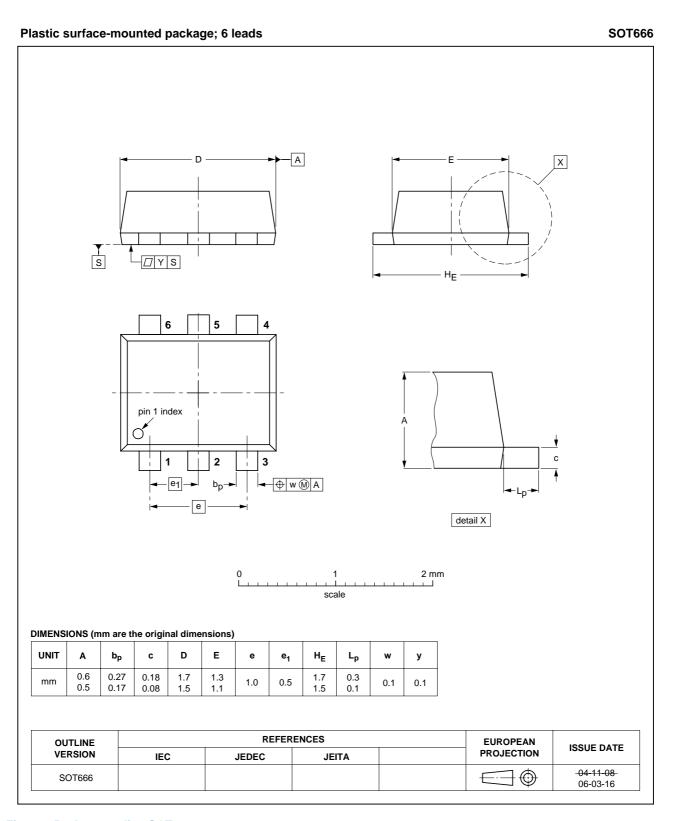


Fig 6. Package outline SOT666

PEMD14_PUMD14_2
Product data sheet

NPN/PNP resistor-equipped transistors; R1 = 47 kΩ, R2 = open

9. Packing information

Table 9. Packing methods

The indicated -xxx are the last three digits of the 12NC ordering code. [1]

| Type number | Package | Description | Packing of | quantity | |
|-------------|---------|------------------------------------|----------------------|----------|-------|
| | | | 3000 | 4000 | 10000 |
| PEMD14 | SOT666 | 4 mm pitch, 8 mm tape and reel | - | -115 | - |
| PUMD14 | SOT363 | 4 mm pitch, 8 mm tape and reel; T1 | 2 -115 | - | -135 |
| PUMD14 | SOT363 | 4 mm pitch, 8 mm tape and reel; T2 | <mark>3]</mark> -125 | - | -165 |

[1] For further information and the availability of packing methods, see Section 12.

[2] T1: normal taping

[3] T2: reverse taping

NPN/PNP resistor-equipped transistors; R1 = 47 kΩ, R2 = open

10. Revision history

| Table 10. Revision histo | ory | | | |
|--------------------------|-----------------|-------------------------------------------------------------|---------------|-----------------|
| Document ID | Release date | Data sheet status | Change notice | Supersedes |
| PEMD14_PUMD14_2 | 20090902 | Product data sheet | - | PEMD14_PUMD14_1 |
| Modifications: | | was changed to reflect the egal definitions and disclair | | |
| | Figure 5 "Packa | age outline SOT363 (SC-88 | 3)": updated | |
| | Figure 6 "Packa | ige outline SOT666": upda | ted | |
| PEMD14_PUMD14_1 | 20050114 | Product data sheet | - | - |

11. Legal information

11.1 Data sheet status

| Document status ^{[1][2]} | Product status ^[3] | Definition |
|-----------------------------------|-------------------------------|---------------------------------------------------------------------------------------|
| Objective [short] data sheet | Development | This document contains data from the objective specification for product development. |
| Preliminary [short] data sheet | Qualification | This document contains data from the preliminary specification. |
| Product [short] data sheet | Production | This document contains the product specification. |

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

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PEMD14_PUMD14_2
Product data sheet

PEMD14; PUMD14

NPN/PNP resistor-equipped transistors; R1 = 47 k Ω , R2 = open

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Date of release: 2 September 2009 Document identifier: PEMD14_PUMD14_2



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